

**Features**

- High current operation for greater luminous output
- Low power consumption and thermal resistance
- Can be used with automatic insertion equipment
- RoHS Compliant



**Benefits:**

- Rugged design allows for easy maintenance
- Robust package for optimum reliability

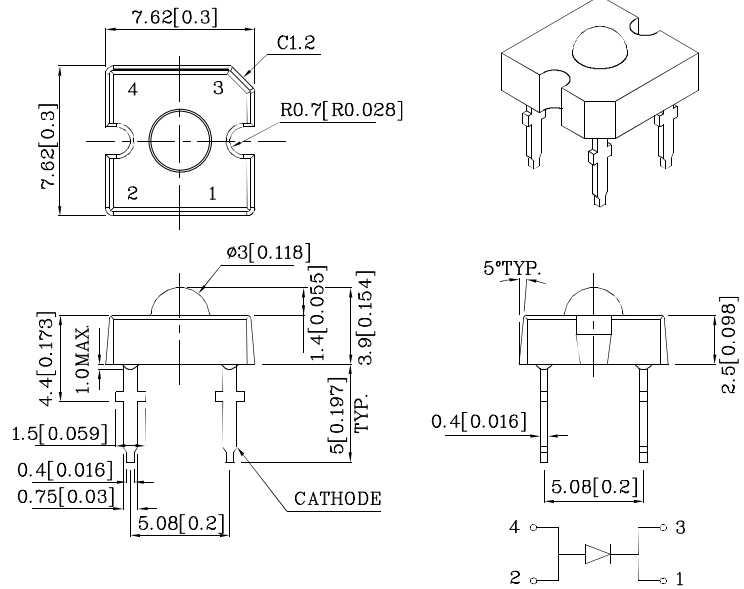
**Typical Applications:**

- Automotive side markers
- Gaming and entertainment lighting
- Signs and road hazard indicators



**ATTENTION**  
OBSERVE PRECAUTIONS  
FOR HANDLING  
ELECTROSTATIC  
DISCHARGE  
SENSITIVE  
DEVICES

**Package Schematics**



**Notes:**

1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25(0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		FWCB (InGaN)	Unit
Reverse Voltage	V <sub>R</sub>	5	V
DC Forward Current	I <sub>F</sub>	30	mA
Power Dissipation	P <sub>D</sub>	126	mW
Operating Temperature	T <sub>A</sub>	-40 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-55 ~ +85	
Electrostatic Discharge Threshold (HBM)		250	V
Lead Solder Temperature [1.5mm Below Seating Plane.][1]		260°C For 5 Seconds	

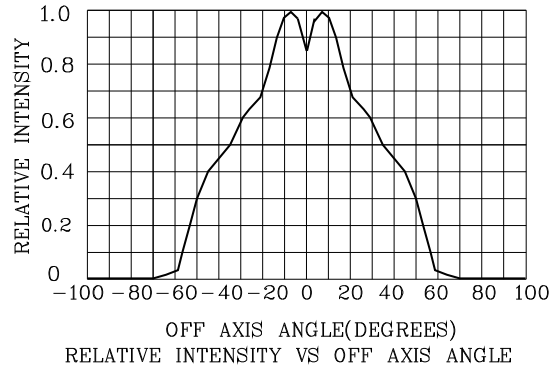
1.No Reflow soldering .

Operating Characteristics (T <sub>A</sub> =25°C)		FWCB (InGaN)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =30mA)	V <sub>F</sub>	3.5	V
Forward Voltage (Max.) (I <sub>F</sub> =30mA)	V <sub>F</sub>	4.2	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	I <sub>R</sub>	50	uA
Chromaticity Coordinates (Typ.)	x	0.31	
	y	0.31	
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	C	100	pF
Thermal Resistance (Typ.)	Rθj-pin	180	°C/W

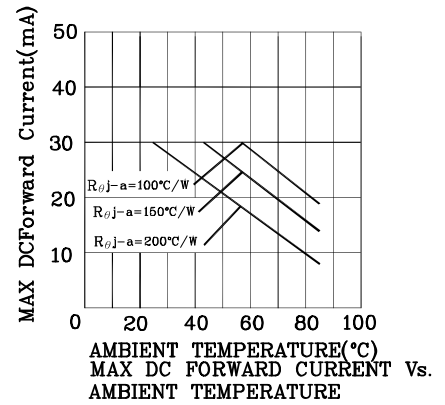
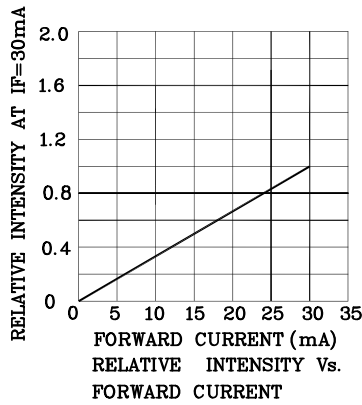
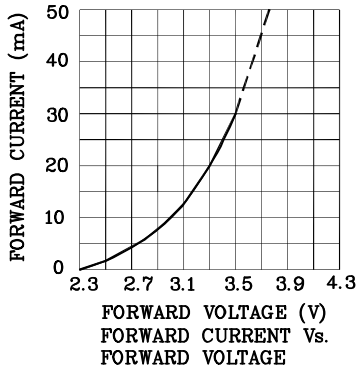
1.The dominant wavelength is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I <sub>F</sub> =30mA) cd		Viewing Angle 2θ 1/2
				min.	typ.	
XSFWCB983W	White	InGaN	Water Clear	3.6	5.19	70°

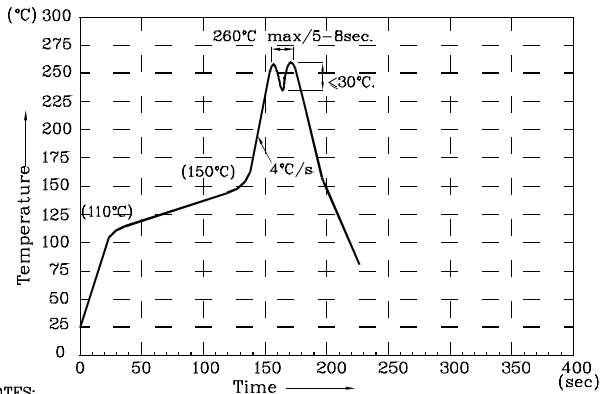
1.Luminous intensity is measured with an integrating sphere after the device has stabilized.  
2.θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.



❖ FWCB



Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. During wave soldering, the PCB top-surface temperature should be kept below 105°C.
5. No more than once.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity/ luminous flux or chromaticity), the typical accuracy of the sorting process is as follows:

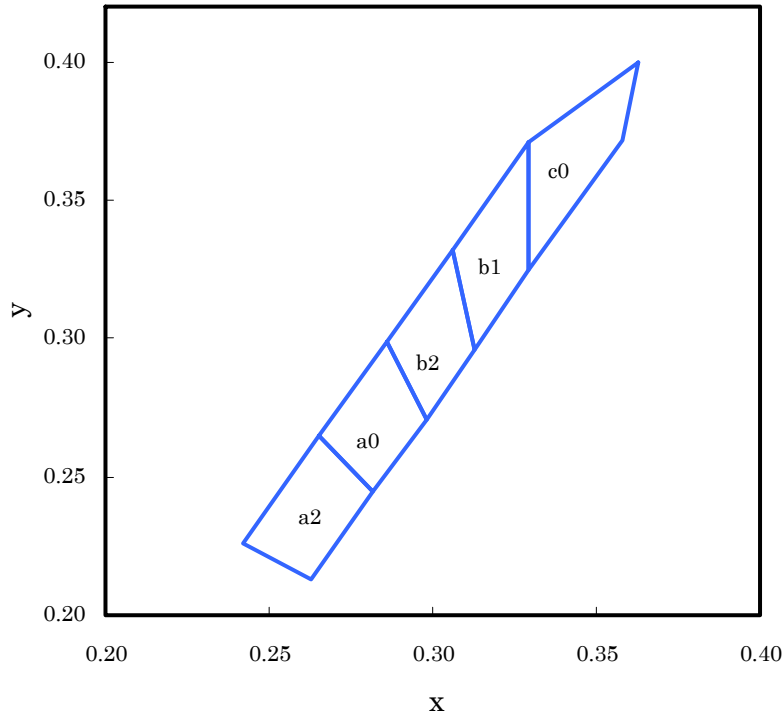
1. Measurement tolerance of the chromaticity coordinates is  $\pm 0.02$ .
2. Luminous Intensity/ Luminous Flux:  $\pm 15\%$
3. Forward Voltage:  $\pm 0.1V$

Note: Accuracy may depend on the sorting parameters.



XSFWCB983W

White CIE



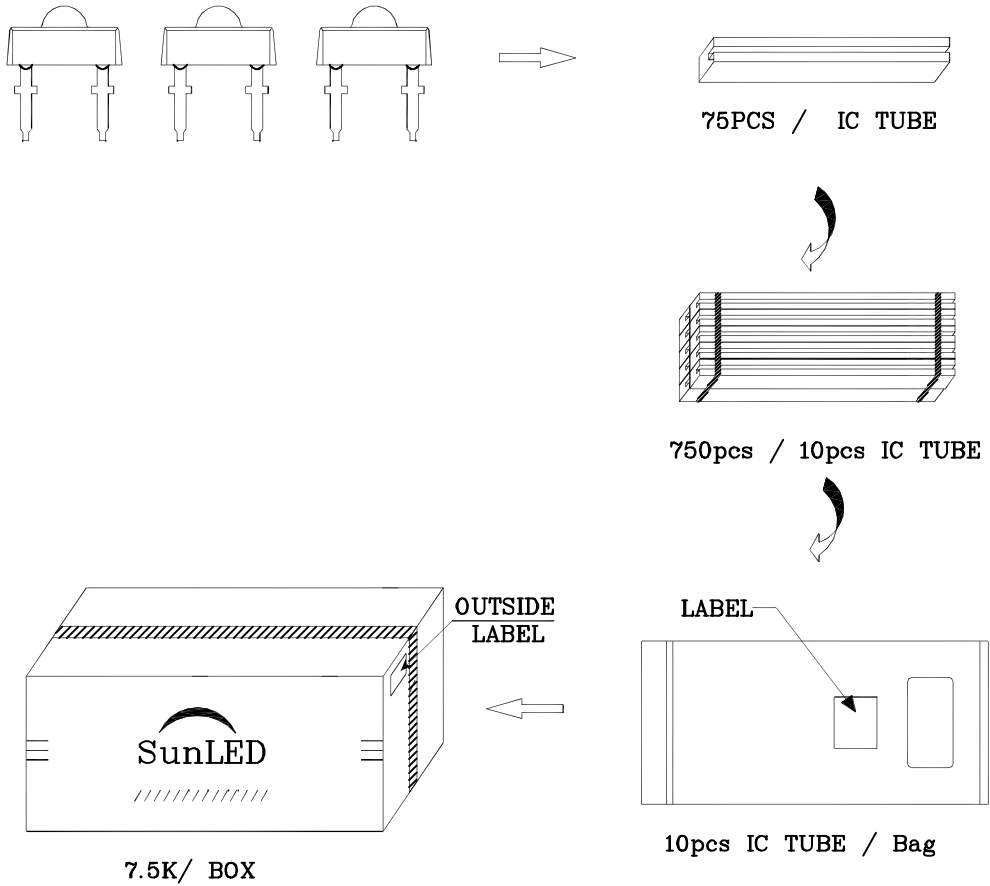
	x	y		x	y		x	y
a2	0.263	0.213	a0	0.282	0.245	b2	0.298	0.271
	0.282	0.245		0.298	0.271		0.313	0.296
	0.265	0.265		0.286	0.299		0.306	0.332
	0.242	0.226		0.265	0.265		0.286	0.299
b1	0.313	0.296	c0	0.329	0.325			
	0.329	0.325		0.358	0.372			
	0.329	0.371		0.363	0.400			
	0.306	0.332		0.329	0.371			


Notes:

Shipment may contain more than one chromaticity regions.  
Orders for single chromaticity region are generally not accepted.  
Measurement tolerance of the chromaticity coordinates is  $\pm 0.02$ .




**PACKING & LABEL SPECIFICATIONS**





Q.C.Q.C  
XX XX XXXX  
PASSED

P/NO : XSxxx983x	
QTY : 750 pcs	CODE: XXX
S/N : XX	
LOT NO:	
 xxxxxxxxxxxxxxxxxxxxxxxx	
RoHS Compliant	